



100V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)} max	Ι _D T _C = +25°C
-100V	240mΩ @ V_{GS} = -10V	-9A
-100V	$300m\Omega @ V_{GS} = -4.5V$	-8A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- **DC-DC Converters**
- Power Management Functions
- Analog Switch

Features

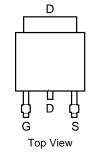
- Low On-Resistance
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

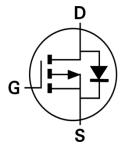
Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (Approximate)



Top View





Internal Schematic

Ordering Information (Note 4)

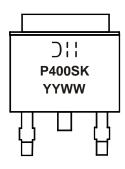
Part Number	Compliance	Case	Packaging
DMP10H400SK3-13	Standard	TO252	2,500/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. Notes:

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds. 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



⊃!! = Manufacturer's Marking P400SK = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 13 = 2013) WW = Week (01 - 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	-100	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 5) V _{GS} = -10V	Steady	$T_C = +25^{\circ}C$	I _D	-9	А
	State	$T_{C} = +100^{\circ}C$		-5.5	
Maximum Body Diode Forward Current (Note 5)	Is	-4	А		
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	-15	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Total Power Dissipation (Note 5)	T _C = +25°C	D	42	W	
Total Power Dissipation (Note 5)	$T_{C} = +100^{\circ}C$	PD	17		
Thermal Resistance, Junction to Ambient (Note 5)		R _{0JA}	44	80 M/	
Thermal Resistance, Junction to Case (Note 5)		R _{0JC}	3	°C/W	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

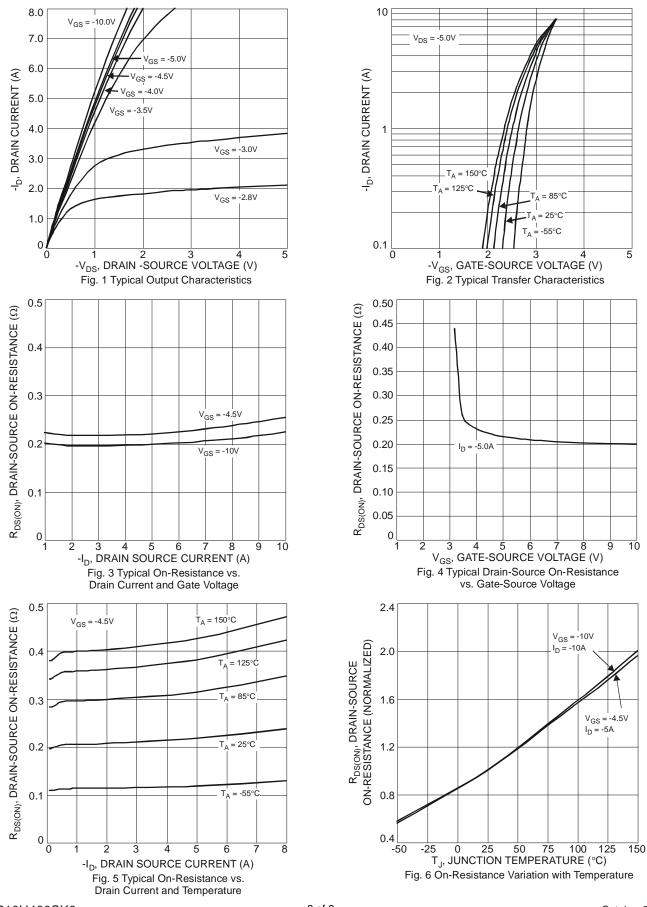
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV _{DSS}	-100	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μA	$V_{DS} = -80V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V _{GS(th)}	-1	_	-3	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	Р		190	240	mΩ	$V_{GS} = -10V, I_D = -5A$
Static Drain-Source Off-Resistance	R _{DS (ON)}		210	300	11152	V _{GS} = -4.5V, I _D =-5A
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -5A$
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	Ciss		1239	—		V_{DS} = -25V, V_{GS} = 0V, f = 1MHz
Output Capacitance	C _{oss}		42		pF	
Reverse Transfer Capacitance	Crss		28	_		
Gate Resistance	R _G		13	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg		8.4	_		
Total Gate Charge (V _{GS} = -10V)	Qg	_	17.5	_	nC	V _{DS} = -60V, I _D = -5A
Gate-Source Charge	Q _{gs}	_	2.8	_		
Gate-Drain Charge	Q _{gd}	_	3.2	_		
Turn-On Delay Time	t _{D(on)}	_	9.1	_		
Turn-On Rise Time	tr	_	14.9	_		V_{DD} = -50V, R_G = 9.1 Ω , I_D = -5A
Turn-Off Delay Time	t _{D(off)}	_	57.4	_	ns	
Turn-Off Fall Time	t _f		34.4		1	
Body Diode Reverse Recovery Time	trr		25.2	_	ns	V _{GS} = 0V, I _S = -5A, dl/dt = 100A/µs
Body Diode Reverse Recovery Charge	Qrr		24.5	_	nC	$V_{GS} = 0V$, $I_{S} = -5A$, $dI/dt = 100A/\mu s$

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.

6. Short duration pulse test used to minimize self-heating effect.

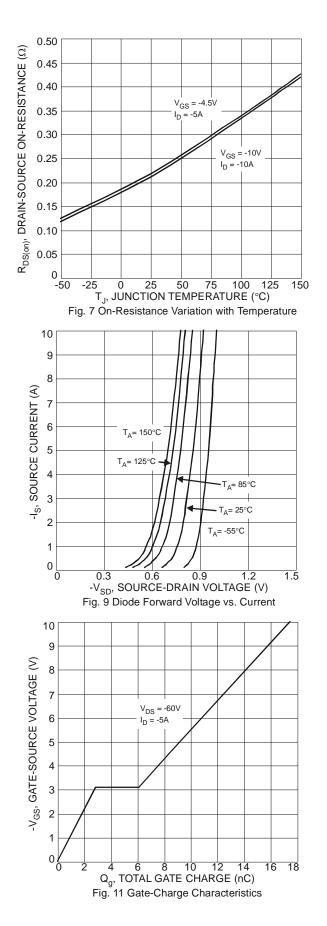
7. Guaranteed by design; not subject to production testing.

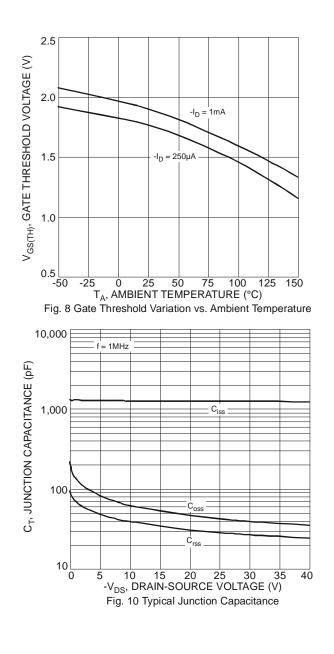




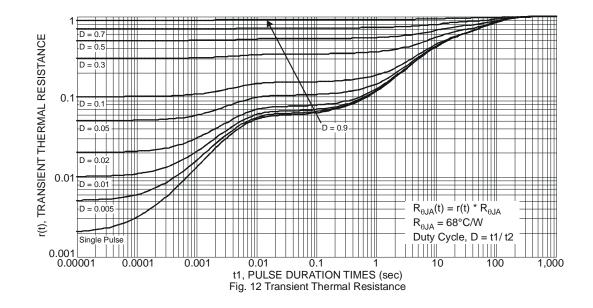
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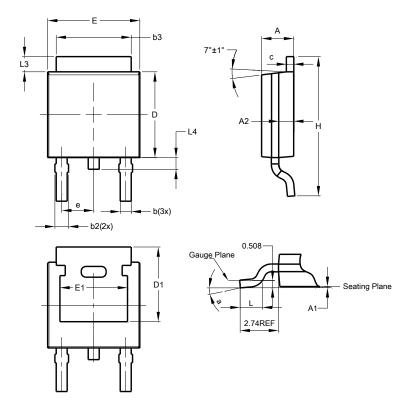






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

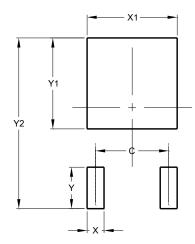


TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Е	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	4.572
Х	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

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